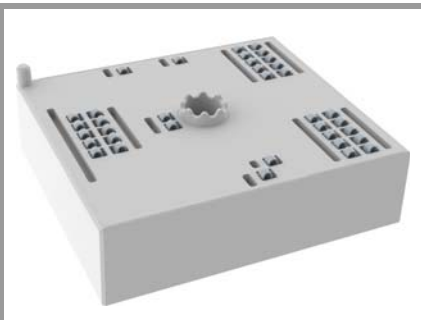


SKiiP 24GB12T7V1



MiniSKiiP® 2 Dual

Half-Bridge

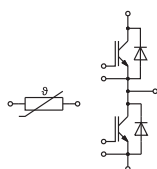
SKiiP 24GB12T7V1

Features*

- 1200V Generation 7 IGBTs (T7)
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532
- NTC T-Sensor

Remarks

-)Max. case temperature limited to $T_C = T_S = 125\text{ °C}$
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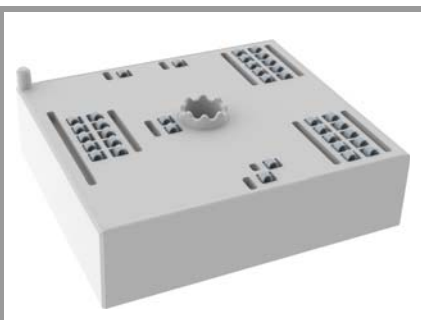


GB

Absolute Maximum Ratings				
Symbol	Conditions		Values	Unit
Inverter - IGBT				
V_{CES}	$T_j = 25\text{ °C}$		1200	V
I_C	$\lambda_{paste} = 0.8\text{ W/(mK)}$	$T_s = 70\text{ °C}$	141	A
		$T_j = 175\text{ °C}$	114	A
I_C	$\lambda_{paste} = 2.5\text{ W/(mK)}$	$T_s = 70\text{ °C}$	163	A
		$T_j = 175\text{ °C}$	131	A
I_{Chom}			150	A
I_{CRM}			300	A
V_{GES}			-20 ... 20	V
t_{psc}	$V_{CC} = 800\text{ V}$ $V_{GE} \leq 15\text{ V}$ $V_{CES} \leq 1200\text{ V}$	$T_j = 175\text{ °C}$	7	μs
T_j			-40 ... 175	$^{\circ}\text{C}$
Inverse - Diode				
V_{RRM}	$T_j = 25\text{ °C}$		1200	V
I_F	$\lambda_{paste} = 0.8\text{ W/(mK)}$	$T_s = 70\text{ °C}$	109	A
		$T_j = 175\text{ °C}$	87	A
I_F	$\lambda_{paste} = 2.5\text{ W/(mK)}$	$T_s = 70\text{ °C}$	127	A
		$T_j = 175\text{ °C}$	101	A
I_{FRM}			300	A
I_{FSM}	$t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 150\text{ °C}$		774	A
T_j			-40 ... 175	$^{\circ}\text{C}$
Module				
$I_{t(RMS)}$	$T_{terminal} = 80\text{ °C}, 20\text{ A per spring}$		200	A
T_{stg}	module without TIM		-40 ... 125	$^{\circ}\text{C}$
V_{isol}	AC sinus 50 Hz, $t = 1\text{ min}$		2500	V

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverter - IGBT						
$V_{CE(sat)}$	$I_C = 150\text{ A}$ $V_{GE} = 15\text{ V}$ chiplevel	$T_j = 25\text{ °C}$	1.55	1.70		V
		$T_j = 150\text{ °C}$	1.73	1.88		V
		$T_j = 175\text{ °C}$	1.77	1.92		V
V_{CE0}	chiplevel	$T_j = 25\text{ °C}$	1.00	1.05		V
		$T_j = 150\text{ °C}$	0.80	0.85		V
		$T_j = 175\text{ °C}$	0.75	0.80		V
r_{CE}	$V_{GE} = 15\text{ V}$ chiplevel	$T_j = 25\text{ °C}$	3.7	4.3		$\text{m}\Omega$
		$T_j = 150\text{ °C}$	6.2	6.9		$\text{m}\Omega$
		$T_j = 175\text{ °C}$	6.8	7.5		$\text{m}\Omega$
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 3.4\text{ mA}$		5.15	5.8	6.45	V
I_{CES}	$V_{GE} = 0\text{ V}, V_{CE} = 1200\text{ V}, T_j = 25\text{ °C}$				1.5	mA
C_{ies}	$V_{CE} = 25\text{ V}$			30.20		nF
C_{oes}	$V_{GE} = 0\text{ V}$			0.39		nF
C_{res}	$f = 1\text{ MHz}$			1.08		nF
Q_G	$V_{GE} = -8\text{ V} \dots +15\text{ V}$			2100		nC
R_{Gint}	$T_j = 25\text{ °C}$			1.0		Ω

SKiiP 24GB12T7V1



MiniSKiiP® 2 Dual

Half-Bridge

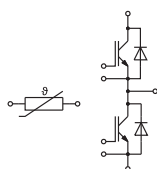
SKiiP 24GB12T7V1

Features*

- 1200V Generation 7 IGBTs (T7)
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- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532
- NTC T-Sensor

Remarks

-)Max. case temperature limited to $T_C = T_S = 125\text{ °C}$
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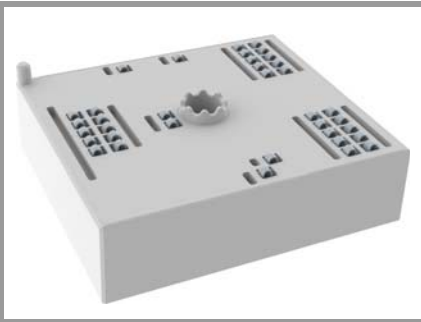


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Characteristics						
Symbol	Conditions	min.	typ.	max.	Unit	
Inverter - IGBT						
$t_{d(on)}$		$T_j = 25\text{ °C}$	173		ns	
		$T_j = 150\text{ °C}$	181		ns	
		$T_j = 175\text{ °C}$	179		ns	
t_r	$V_{CC} = 600\text{ V}$ $I_C = 150\text{ A}$	$T_j = 25\text{ °C}$	32		ns	
		$T_j = 150\text{ °C}$	37		ns	
		$T_j = 175\text{ °C}$	39		ns	
E_{on}	$R_{G, on} = 1.1\ \Omega$ $R_{G, off} = 1.1\ \Omega$ $V_{GE} = +15/-15\text{ V}$	$T_j = 25\text{ °C}$	6.3		mJ	
		$T_j = 150\text{ °C}$	11		mJ	
		$T_j = 175\text{ °C}$	12		mJ	
$t_{d(off)}$		$T_j = 25\text{ °C}$	347		ns	
		@ $T_j = 150\text{ °C}$: $di/dt_{on} = 5650\text{ A}/\mu\text{s}$	$T_j = 150\text{ °C}$	437		ns
		$T_j = 175\text{ °C}$	462		ns	
t_f	$di/dt_{off} = 1530\text{ A}/\mu\text{s}$ $dv/dt = 3730\text{ V}/\mu\text{s}$	$T_j = 25\text{ °C}$	67		ns	
		$T_j = 150\text{ °C}$	103		ns	
		$T_j = 175\text{ °C}$	130		ns	
E_{off}		$T_j = 25\text{ °C}$	10		mJ	
		$T_j = 150\text{ °C}$	17		mJ	
		$T_j = 175\text{ °C}$	18		mJ	
$R_{th(j-s)}$	per IGBT, $\lambda_{paste} = 0.8\text{ W}/(\text{mK})$		0.4		K/W	
$R_{th(j-s)}$	per IGBT, $\lambda_{paste} = 2.5\text{ W}/(\text{mK})$		0.32		K/W	

Characteristics					
Symbol	Conditions	min.	typ.	max.	Unit
Inverse - Diode					
$V_F = V_{EC}$	$I_F = 150\text{ A}$ $V_{GE} = 0\text{ V}$ chipelevel	$T_j = 25\text{ °C}$	2.17	2.49	V
		$T_j = 150\text{ °C}$	2.11	2.42	V
		$T_j = 175\text{ °C}$	1.96	2.27	V
V_{F0}	chipelevel	$T_j = 25\text{ °C}$	1.30	1.50	V
		$T_j = 150\text{ °C}$	0.90	1.10	V
		$T_j = 175\text{ °C}$	0.82	0.98	V
r_F	chipelevel	$T_j = 25\text{ °C}$	5.8	6.6	m Ω
		$T_j = 150\text{ °C}$	8.1	8.8	m Ω
		$T_j = 175\text{ °C}$	7.6	8.6	m Ω
I_{RRM}		$T_j = 25\text{ °C}$	197		A
		$T_j = 150\text{ °C}$	228		A
		$T_j = 175\text{ °C}$	256		A
Q_{rr}	$I_F = 150\text{ A}$ $V_{GE} = +15/-15\text{ V}$ $V_{CC} = 600\text{ V}$	$T_j = 25\text{ °C}$	13		μC
		$T_j = 150\text{ °C}$	26		μC
		@ $T_j = 150\text{ °C}$: $di/dt_{off} = 5550\text{ A}/\mu\text{s}$	$T_j = 175\text{ °C}$	25	
E_{rr}		$T_j = 25\text{ °C}$	5		mJ
		$T_j = 150\text{ °C}$	11		mJ
		$T_j = 175\text{ °C}$	12		mJ
$R_{th(j-s)}$	per Diode, $\lambda_{paste} = 0.8\text{ W}/(\text{mK})$		0.5		K/W
$R_{th(j-s)}$	per Diode, $\lambda_{paste} = 2.5\text{ W}/(\text{mK})$		0.4		K/W
Module					
L_{CE}			20		nH
M_s	to heat sink	2		2.5	Nm
w			50		g

SKiiP 24GB12T7V1



MiniSKiiP® 2 Dual

Characteristics					
Symbol	Conditions	min.	typ.	max.	Unit
Temperature Sensor					
R ₁₀₀	T _c =100°C (R ₂₅ =5 kΩ)		493 ± 5%		Ω
B _{100/125}	R _(T) =R ₁₀₀ exp[B _{100/125} (1/T-1/T ₁₀₀)]; T[K];		3550 ±2%		K

Half-Bridge

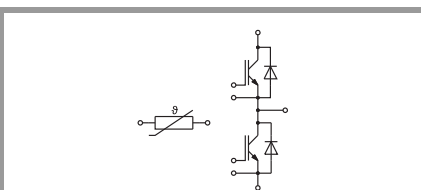
SKiiP 24GB12T7V1

Features*

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Remarks

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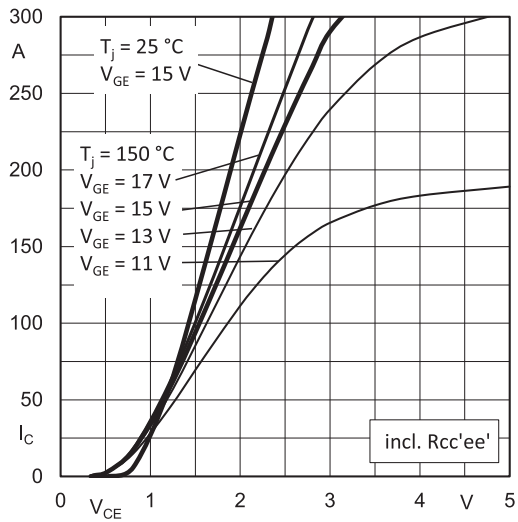


Fig. 1: Typ. output characteristic

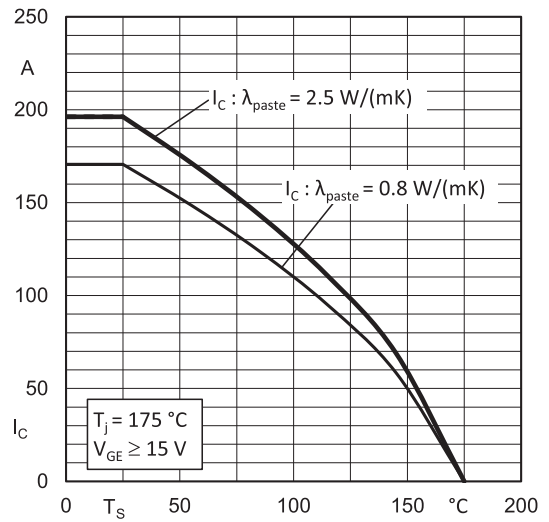


Fig. 2: Rated current vs. temperature $I_C = f(T_S)$

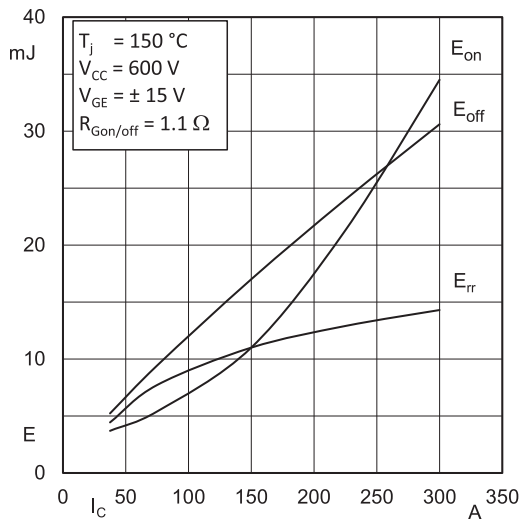


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

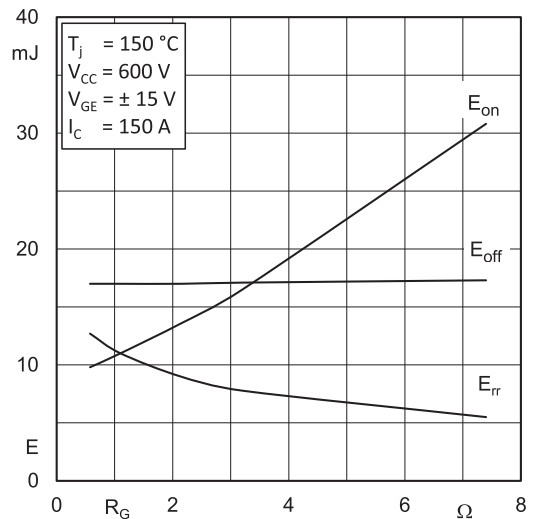


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

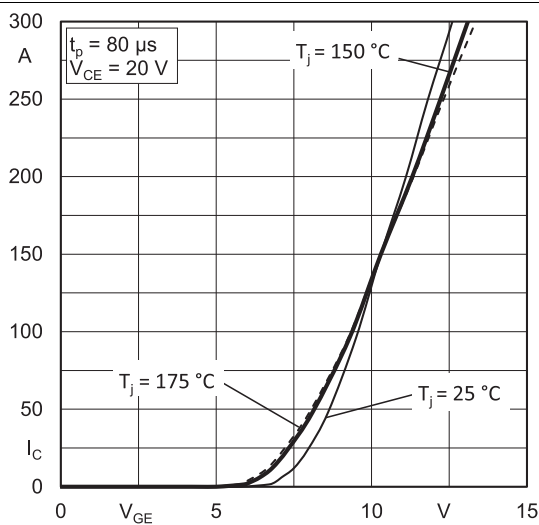


Fig. 5: Typ. transfer characteristic

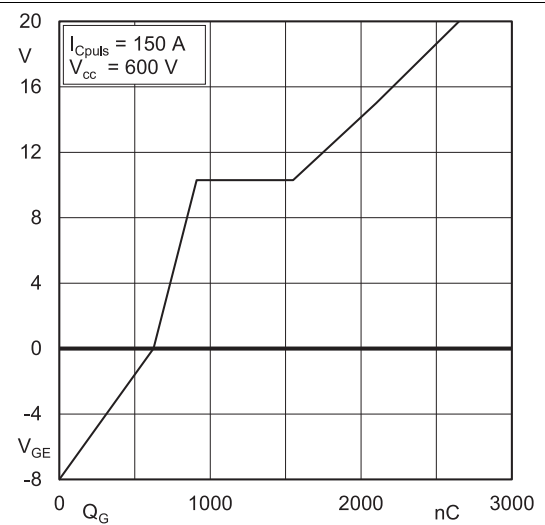


Fig. 6: Typ. gate charge characteristic

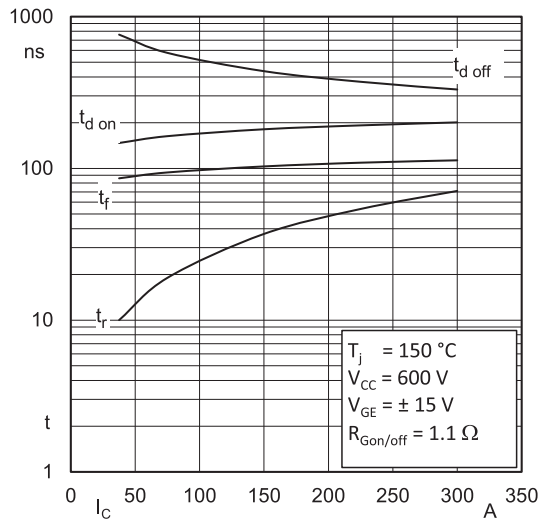


Fig. 7: Typ. switching times vs. I_C

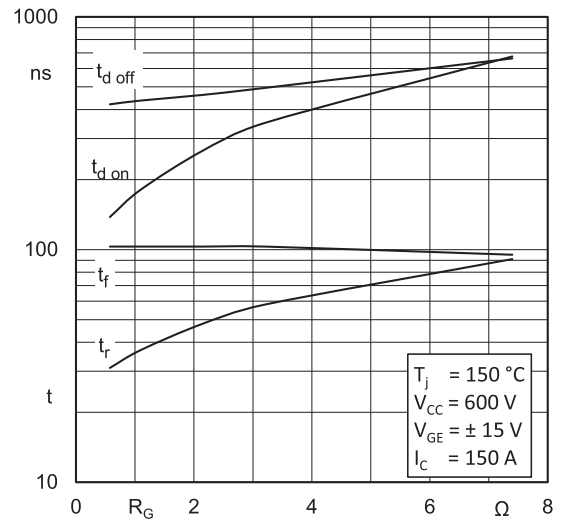


Fig. 8: Typ. switching times vs. gate resistor R_G

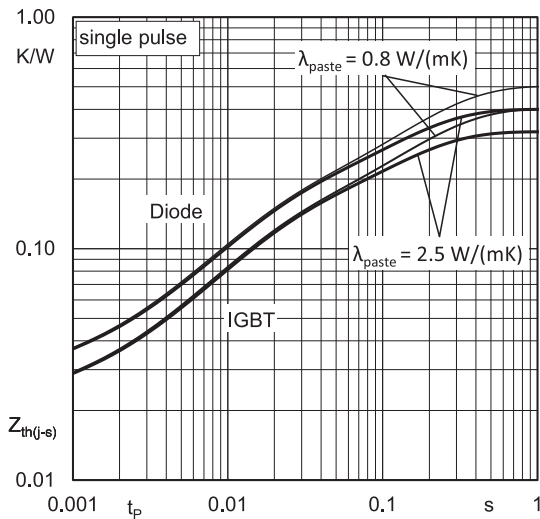


Fig. 9: Typ. transient thermal impedance

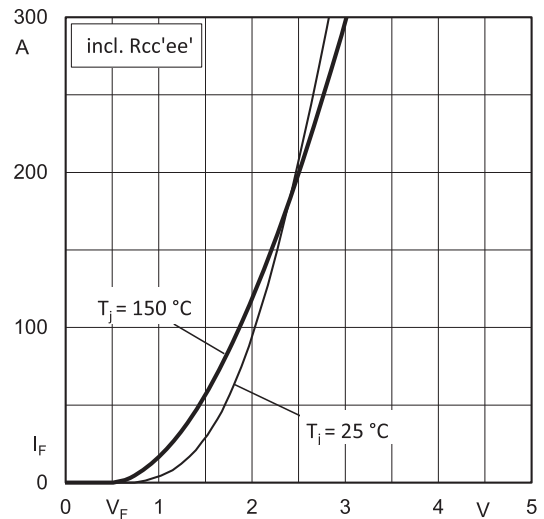


Fig. 10: Typ. CAL diode forward characteristic

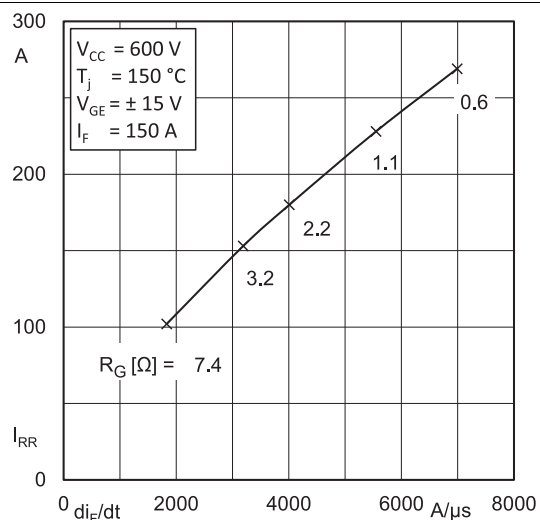


Fig. 11: Typ. CAL diode peak reverse recovery current

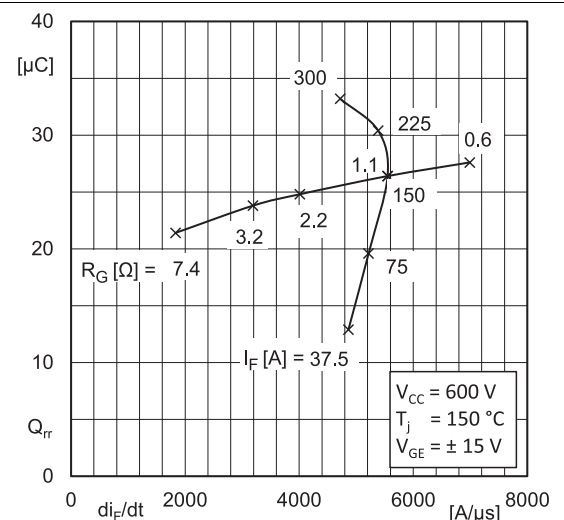
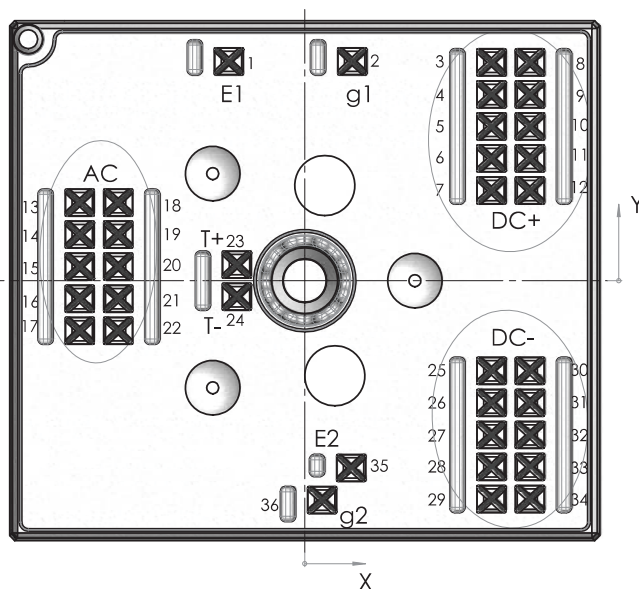


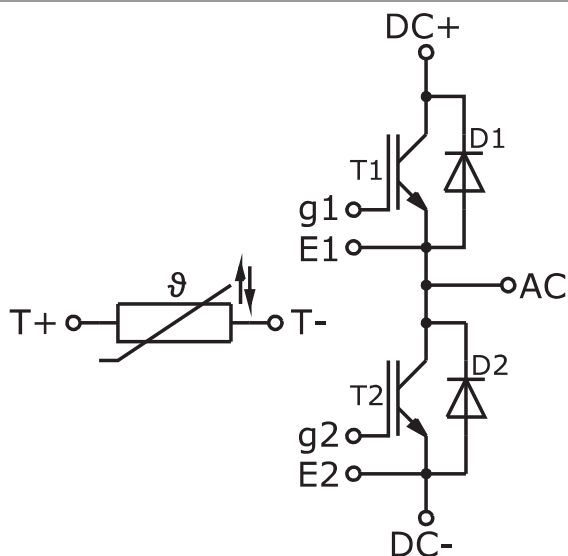
Fig. 12: Typ. CAL diode recovery charge

Pin out							
Pin	X	Y	Function	Pin	X	Y	Function
1	-7,58	21,9	E1	19	-18,62	4,6	AC
2	4,72	21,9	g1	20	-18,62	1,4	AC
3	18,62	21,8	DC+	21	-18,62	-1,8	AC
4	18,62	18,6	DC+	22	-18,62	-5	AC
5	18,62	15,4	DC+	23	-6,78	1,6	T+
6	18,62	12,2	DC+	24	-6,78	-1,6	T-
7	18,62	9	DC+	25	18,62	-9	DC-
8	22,48	21,8	DC+	26	18,62	-12,2	DC-
9	22,48	18,6	DC+	27	18,62	-15,4	DC-
10	22,48	15,4	DC+	28	18,62	-18,6	DC-
11	22,48	12,2	DC+	29	18,62	-21,8	DC-
12	22,48	9	DC+	30	22,48	-9	DC-
13	-22,48	7,8	AC	31	22,48	-12,2	DC-
14	-22,48	4,6	AC	32	22,48	-15,4	DC-
15	-22,48	1,4	AC	33	22,48	-18,6	DC-
16	-22,48	-1,8	AC	34	22,48	-21,8	DC-
17	-22,48	-5	AC	35	4,62	-18,7	E2
18	-18,62	7,8	AC	36	1,72	-21,9	g2

all values in mm



Pinout and Dimensions



Pinout

This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

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